Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.66 V Max @ 1.0 A, $T_I = 150^{\circ}C$)
- NRVUA and SURA8 Prefixes for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable*
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 70 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection:
 - Human Body Model > 4000 V (Class 3)
 - Machine Model > 400 V (Class C)



ON Semiconductor[®]

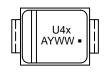
www.onsemi.com

ULTRAFAST RECTIFIERS **1 AMPERE, 50–100 VOLTS**



SMA CASE 403D

MARKING DIAGRAM



U4x = Specific Device Code

- A for MURA105T3G, SURA8105T3G х =
 - B for MURA/NRVUA/SURA8110T3G =
- Assembly Location А = Y
 - = Year
- Work Week WW =
 - Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]		
MURA105T3G	SMA (Pb–Free)	5, 000 / Tape & Reel		
SURA8105T3G*	SMA (Pb–Free)	5, 000 / Tape & Reel		
MURA110T3G	SMA (Pb–Free)	5,000 / Tape & Reel		
NRVUA110VT3G*	SMA (Pb–Free)	5,000 / Tape & Reel		
SURA8110T3G*	SMA (Pb–Free)	5,000 / Tape & Reel		

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURA105T3G, SURA8105T3G MURA110T3G, SURA8110T3G, NRVUA110VT3G	V _{RRM} V _{RWM} V _R	50 100	V
Average Rectified Forward Current @ $T_L = 155^{\circ}C$ @ $T_L = 135^{\circ}C$	I _{F(AV)}	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	50	А
Operating Junction Temperature Range	TJ	-65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Lead (Note 1)	Psi _{JL} (Note 2)	24	°C/W
Thermal Resistance, Junction-to-Ambient (Note 1)	R _{0JA}	216	

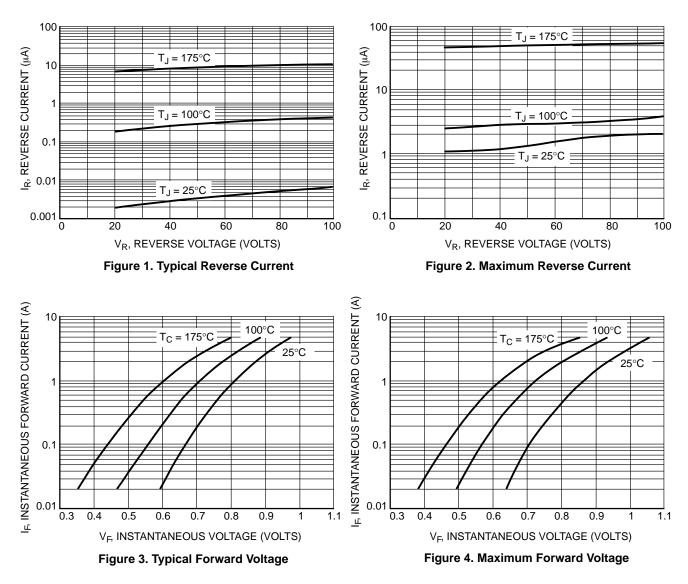
1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR–4. 2. In compliance with JEDEC 51, these values (historically represented by $R_{\theta JL}$) are now referenced as Psi_{JL} .

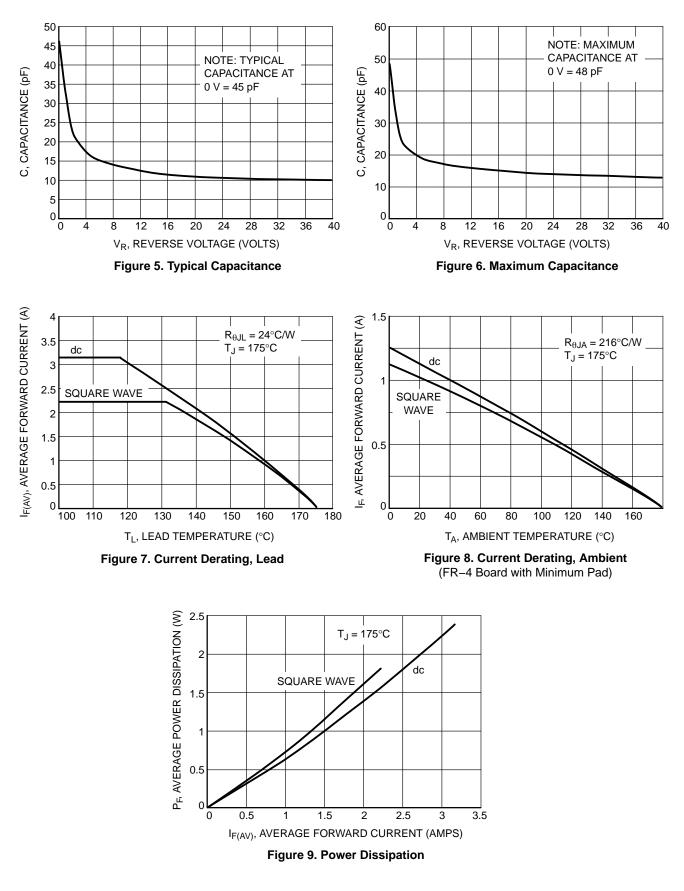
ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 3) ($i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$) ($i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C}$)	v _F	0.875 0.66	V
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 150^{\circ}C$)	İR	2.0 50	μΑ
Maximum Reverse Recovery Time $(i_F = 1.0 \text{ A}, \text{ di/dt} = 50 \text{ A/}\mu\text{s})$	t _{rr}	30	ns

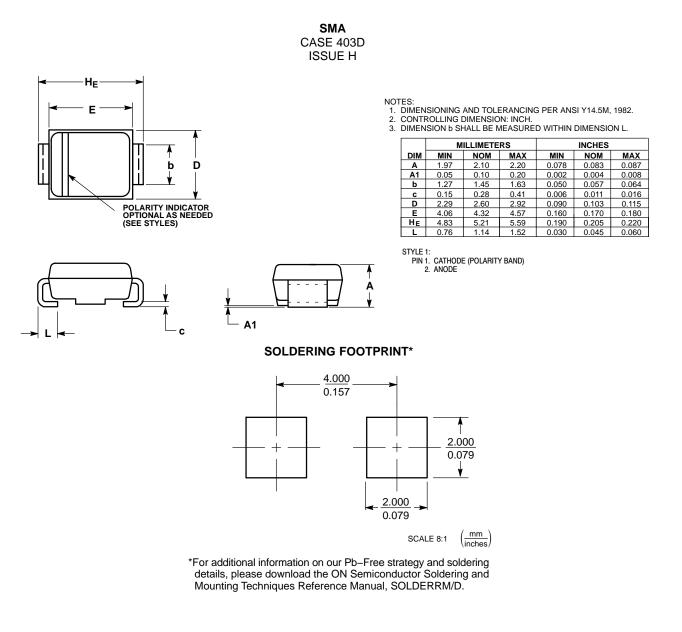
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.





PACKAGE DIMENSIONS



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